IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit

: 1771

: A. Singh

Examiner Serial No.

: 09/101,251

Filed Inventors July 15, 1998 Soichi Ishibashi

Title

: Tetsuyuki Kyono : A MOLDING MATERIAL AND

A PRODUCTION PROCESS

THEREOF

Docket: 1066-98

1600 Market Street

Philadelphia, PA 19103

36th Floor

Dated: July 11, 2000

DECLARATION OF AUSTIN R. MILLER

Assistant Commissioner for Patents Washington, DC 20231

Sir:

I, Austin R. Miller, declare that I have prepared the attached substitute specification entitled A MOLDING MATERIAL AND PRODUCTION PROCESS. This substitute specification is derived from the original Application Serial No. 09/101,251, filed July 15, 1998, and incorporates the amendments to the specification which are included in the prosecution. I hereby certify that to the best of my knowledge and belief, this substitute specification does not contain any new subject matter.

I also declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and thus such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: July 13, 2000

Austin R. Miller, Reg. No. 16,602

	ب	Original Application						
		PCT National Application U.S. Designated Office						
		Continuation or Divisional Application						
		Continuation-in-Part Application						
	COMBINED DECLARATION, POWER OF ATTORNEY AND PETITION							
-	As a below named inventor, I hereby declare that:							
	My residence, post office address and citizenship are as stated below next to my name,							
	I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled							
Ö	which is described in the specification and claims							
n E	attached hereto.							
	☐ filed on							
	Application Serial No.							
	and was amended on							
	(if applicable)							
	which is described in International Application No. PCT/JP97/04049 filed November 6, 1997 and as amended on (if any),							
	which	I have reviewed and for which I solicit a United States patent.						
	I hora	by state that I have reviewed and understand the contents of the above identified specification, including the						

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I do not know and do not believe that this invention was ever known or used in the United States before my or our invention thereof or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application or said international application, or in public use or on sale in the United States of America more than one year prior to this application or said international application, or that the invention has been patented or made the subject of an inventor's certificate issued before the date of this application or said international application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application or said international application, or that any application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to this application or said international application by me or my legal representatives or assigns except as identified below.

Attorney Docket No. 1066-98

Priority Claimed

Date of Filing (day, month, year)

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign applications for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Country

Number

	Japan	06,11,96	■ yes	□ no					
			□ yes	□ no					
			□ yes	□ no					
			yes	□ no					
			□ yes	□ no					
I hereby claim the benefit under Title 35, United States Code, §119 or §120 (as applicable) of any United State application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application(s) in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations §1.56(a) which occurred between the filing date of the prior application(s) and the national or PCT international filing date of this application:									
(Application Serial No.)	a	Filing Date)	(Status) (patented	d,pending,abandone					
			`	(Status) (patented, pending, abandoned					
(Application Serial No.)	(1	Filing Date)	(Status) (patented	d,pending,abandone					
POWER OF ATTORNE	EY: As a named inv	entor, I hereby appoint the foll	owing attorneys to prose						
POWER OF ATTORNE	EY: As a named involved in the United State A T F	entor, I hereby appoint the folles Patent and Trademark Officustin R. Miller Reg. N. Daniel Christenbury Reg. N. Trank A. Cona Reg. N. avid A. Sasso Reg. N.	owing attorneys to prose						

I hereby petition for grant of a United States Letters Patent on this invention.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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	1. FULL NAME OF SOLE OR FIRST INVENTOR Soichi Ishibashi	INVENT	POR'S SIGNATURE UShi Oshibashi	DATE	7/7/98				
ı	RESIDENCE		CITIZENSHIP						
	Ehime Japan	Japan							
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B	Seto-ryo, 1456, Oaza-Tsutsui, Masaki-cho, Iyo-gun, Ehime 791-31 Japan								
	2. FULL NAME OF JOINT INVENTOR, IF ANY	INVENT	INVENTOR'S SIGNATURE 4 DATE						
_	Tetsuyuki Kyono		Etrayahi Kni	1	7/2/98				
i I	RESIDENCE		CITIZENSHIP						
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ñ (POST OFFICE ADDRESS								
	11-12-901 Iwasaki-cho 2-chome, Matsuyama-shi, Ehime 790	Japan							
	3. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY		INVENTOR'S SIGNATURE		DATE				
	RESIDENCE		CITIZENSHIP						
	POST OFFICE ADDRESS								
<u>.</u>	4. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY		INVENTOR'S SIGNATURE		DATE				
	RESIDENCE		CITIZENSHIP						
	POST OFFICE ADDRESS								
	5. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY		INVENTOR'S SIGNATURE		DATE				
	RESIDENCE		CITIZENSHIP						
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	6. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY		INVENTOR'S SIGNATURE		DATE				
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	POST OFFICE ADDRESS								
	7. FULL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY		INVENTOR'S SIGNATURE DATE		DATE				
	RESIDENCE	CITIZEN	CITIZENSHIP						
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